

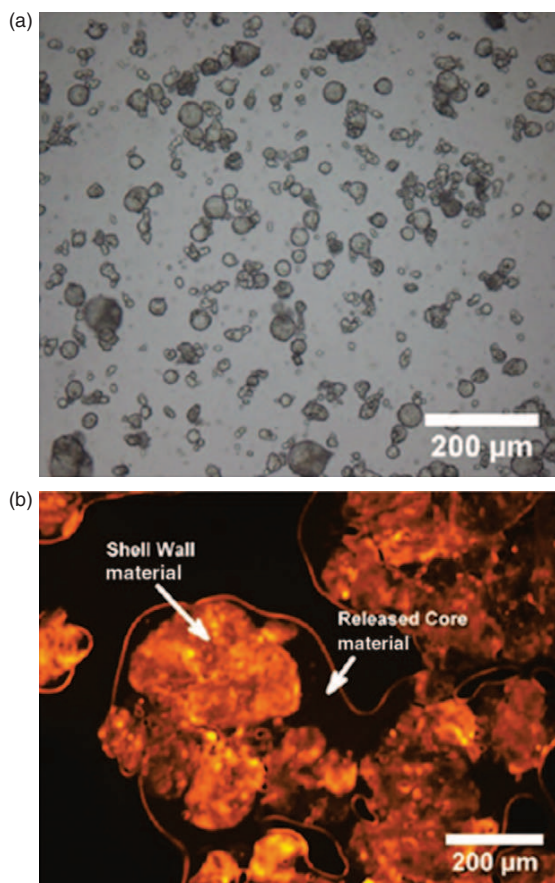
**Scheme 9** General epoxy resin curing between a diepoxide (functionality ( $f$ ) = 2) and diamine ( $f$  = 4).

and crosslink density directly influences the polymer storage modulus increase as the epoxy resin cures. Because the chain mobility of the polymer thermoset decreases with crosslinking, the  $T_g$  also begins to rise as the curing process occurs.

**Scheme 9** represents a general epoxy resin curing reaction between a diepoxide and diamines. The reaction of the epoxide ring can occur between an electrophile or a nucleophile to generate the ring-opening reaction and the subsequent alcohol. In general, the primary and secondary alcohols can be produced, since in theory, both carbons of the epoxide ring are likely to react with the nucleophile or electrophile. However, the sterics of the reaction generally leads to the attack of the less sterically hindered carbon and subsequently the secondary alcohol as seen in **Scheme 9**. Common nucleophiles used in epoxy reactions are alcohols, amines, and carboxylic acids. Alkyl halides and isocyanates are possible electrophilic reactants with epoxides as well.

Epoxy curing has found vast utility in self-healing applications since the reaction occurs quickly and without any aid of catalysts. In many self-healing systems, microcapsules containing a reactant or catalyst are generated and blended into a binary polymer matrix. Upon stress or mechanical damage, the microcapsule will rupture and react with the surrounding matrix to repair the polymer damage. The curing agent or compound held within the microcapsule contains the same chemistry as the polymer matrix to repair the damage with the same polymer composition to maintain matrix homogeneity. Epoxide reactions offer advantages such as a fast cure which is often necessary for quick polymer repair.

Recently, Sottos and co-workers developed a method to prepare microcapsules containing reactive amines using interfacial polymerization rather than conventional emulsion techniques to create the walls of the microparticles.<sup>118</sup> These particles were intended for epoxy adhesive applications with potential self-healing properties. The capsules contained the very reactive diethylene triamine which was created using a water-in-oil emulsion method and stabilized in a nanoclay suspension with polyisobutylene (PIB). Upon removal of PIB, the particles were quickly reacted with TDI to create a polyurea wall. Careful addition of the TDI allowed for unaggregated microparticles with diameters averaging about  $26 \pm 10 \mu\text{m}$  (**Figure 21**). The amine-containing capsules were blended with epoxy resin and curing was performed upon added pressure to rupture the capsules.



**Figure 21** Micrographs of epoxy-cured polymer composites: (a) optical micrograph of amine-filled microcapsules in solution for self-healing epoxy composites; (b) fluorescence micrograph reflecting the response of microcapsules under applied pressure.<sup>118</sup> Reprinted with permission from Wang, W.; Jin, Y.; Ping, P.; *et al. Macromolecules* **2010**, *43* (6), 2942–2947.<sup>111</sup> Copyright (2010) American Chemical Society.